





SC, T SERIES

# **MACHINED TERMINALS & SOCKETS**

### **SPECIFICATIONS**

Contact: BeCu -GG Plating:

30 μ" (0.76 μm) Au over 50 μ" (1.27 μm) Ni on contact; 10 μ" (0.25 μm) Au over 50 μ" (1.27 μm) Ni on shell -GT Plating:

30 μ" (0.76 μm) Au over 50 μ" (1.27 μm) Ni on contact; Sn over 50 μ" (1.27 μm) Ni

on shell

on shell
-TT Plating:
Sn over 50 μ" (1.27 μm)
Ni on contact; Sn over
50 μ" (1.27 μm) Ni on shell
-ST Plating:

10 μ" (0.25 μm) Au over 50 μ" (1.27 μm) Ni on contact; Sn over 50 μ" (1.27 μm) Ni on shell

Lead DIA Accepted: (0.38 mm) .015" to (0.56 mm) .022" and most IC léads

#### **SPECIFICATIONS**

#### SC-1P4

Contact: BeCu -GG Plating: 20 μ" (0.51 μm) Au over 50 μ" (1.27 μm) Ni on contact -GT Plating: 20 μ" (0.51 μm) Au over 50 μ" (1.27 μm) Ni on contact Insertion Force: 6.5 oz (1.81 N) avg 13 oz (3.62 N) max (.032" (0.81 mm) DIA probe) Withdrawal Force:

2 oz (0 56 N) min (.032" (0.81 mm) DIA probe)

#### **SPECIFICATIONS**

#### T-1S6

T Series is available with a choice of Gold or Tin plating. Add -G or -T as a suffix to the part number shown.

-G Plating: Au over 50 u (1.27 µm) Ni

-T Plating:

Sn over  $50~\mu$ " (1.27  $\mu$ m) Ni or 100  $\mu$ " (2.54  $\mu$ m) Cu

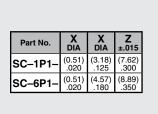
Some sizes, styles and options are non-standard,

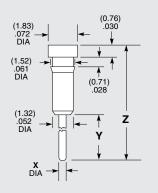
non-returnable.

#### RECOMMENDED PC HOLE SIZE: LEAD SIZE (0.46) .018 DIA (0.61) .024 DIA (0.51) .020 DIA (0.66) .026 DIA (0.64) .025 DIA (0.79) .031 DIA (0.76) .030 DIA (0.91) .036 DIA (0.89) .035 DIA (1.04) .041 DIA (1.14) .045 DIA (1.30) .051 DIA (1.32) .052 DIA (1.47) .058 DIA (0.46) .018 SQ (0.76) .030 DIA (0.64) .025 SQ (1.02) .040 DIA (1.14) .045 SQ (1.75) .069 DIA (0.20) .008 x (0.71) .028 (0.89) .035 DIA (0.25) .010 x (0.51) .020 (0.71) 028 DIA (0.41) .016 x (0.51) .020 (0.79) .031 DIA (0.41) .016 x (0.61) .024 (0.89) .035 DIA (0.41) .016 x (0.79) .031 (1 04) 041 DIA

Insertion Depth =  $(4.45 \text{ mm}).175^{\circ}$  to  $(5.46 \text{ mm}).215^{\circ}$  Lead DIA Accepted =  $(0.81 \text{ mm}).032^{\circ}$  to  $(0.97 \text{ mm}).038^{\circ}$  Plating Available = GG, GT

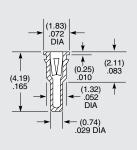
## SC-1P1-, SC-6P1-





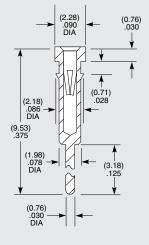
Insertion Depth (SC-1P1, SC-6P1) =  $(2.41 \text{ mm}) \cdot 95^\circ$  to  $(3.68 \text{ mm}) \cdot 145^\circ$  Plating Available (SC-1P1) = GG, GT, TT, ST Plating Available (SC-6P1) = GG, GT

## SC-8P1

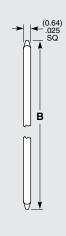


 $\label{eq:loss} \begin{array}{l} \mbox{Insertion Depth} = (2.16 \mbox{ mm}) \mbox{.085" to } .140" \mbox{(} 3.56 \mbox{ mm}) \\ \mbox{Lead DIA Accepted: (} 0.41 \mbox{ mm}) \mbox{.016" to (} 0.51 \mbox{ mm}) \mbox{.020"} \\ \mbox{Plating Available} = \mbox{GG, GT, TT} \end{array}$ 

## SC-1P4-



T-1S6-



PART NO.	В
T-1S6-07-X-2	(10.92) .430
T-1S6-08-X-2	(13.46) .530
T-1S6-09-X-2	(18.54) .730
T-1S6-10-X-2	(21.08) .830
T-1S6-11-X-2	(23.62) .930
T-1S6-12-X-2	(26.16) 1.030
T-1S6-13-X-2	(31.24) 1.230
T-1S6-14-X-2	(36.32) 1.430
T-1S6-15-X-2	(16.00) .630
T-1S6-16-X-2	(11.30) .445
T-1S6-17-X-2	(12.19) .480
T-1S6-18-X-2	(7.62) .300
T-1S6-19-X-2	(33.78) 1.330
T-1S6-20-X-2	(28.70) 1.130
T-1S6-21-X-2	(8.51) .335

Pins are supplied on a bandolier.

Material: Phosphor Bronze X = Plating option (specify G or T)

-G = 10  $\mu^{\shortparallel}$  (0.25  $\mu m)$  Gold on (4.19 mm) .165" contact area. Gold flash on balance

-T = 200 μ" (5.08 μm) Tin